## DZ2S110

### Silicon epitaxial planar type

For constant voltage / waveform clipper and surge absorption circuit Low noise type DZ2J110 in SSMini2 type package

### Features

- Excellent rising characteristics of zener current Iz
- Low zener operating resistance  $R_Z$
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

### Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

# ■ Absolute Maximum Ratings T<sub>a</sub> = 25°C Parameter Symbol Rating

	- ,	- 3	
Repetitive peak forward current	I <sub>FRM</sub>	200	mA
Total power dissipation *	P <sub>T</sub>	150	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*:  $P_T = 150 \text{ mW}$  achieved with a printed circuit board.

### Common Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$			1.0	V
Zener voltage *1, 2, 4	Vz	$I_Z = 5 \text{ mA}$	10.45		11.55	V
Zener operating resistance	R <sub>Z</sub>	$I_Z = 5 \text{ mA}$			30	Ω
Zener rise operating resistance	R <sub>ZK</sub>	$I_{Z} = 0.5 \text{ mA}$			60	Ω
Reverse current	I <sub>R</sub>	$V_R = 8 V$			0.05	μΑ
Temperature coefficient of zener voltage *3	Sz	$I_Z = 5 \text{ mA}$		8.3		mV/°C

Unit

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 5 MHz.

3. \*1: The temperature must be controlled 25°C for  $V_Z$  measurement.  $V_Z$  value measured at other temperature must be adjusted to  $V_Z$  (25°C) \*2:  $V_Z$  guaranteed 20 ms after current flow.

\*3:  $T_i = 25^{\circ}C$  to  $150^{\circ}C$ 

\*4: Rank classification

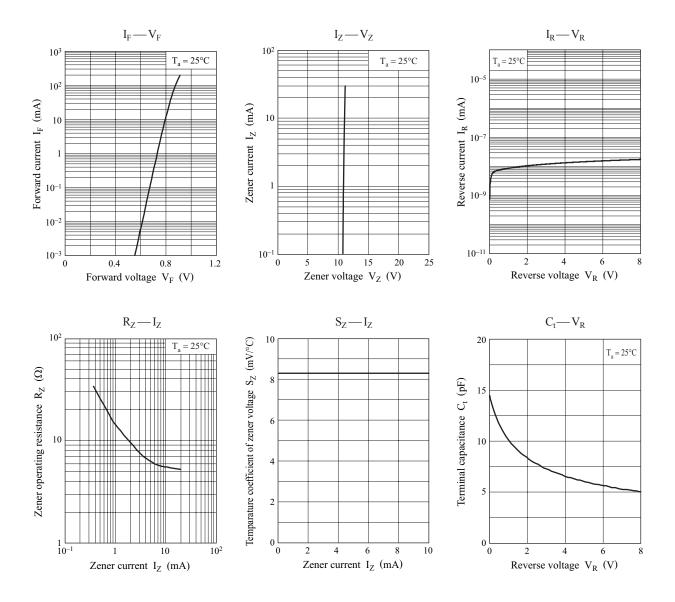
Code	М	0	
Rank	M No-ran		
Vz	10.73 to 11.28	10.45 to 11.55	
Marking Symbol	PU	РЈ	

- Package
- Code
- SSMini2-F5-B
- Pin Name
  - 1. Cathode
  - 2. Anode

Marking Symbol: PJ, PU

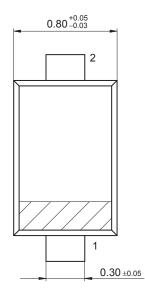
### DZ2S110

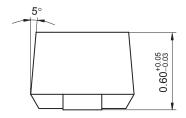
### **Panasonic**

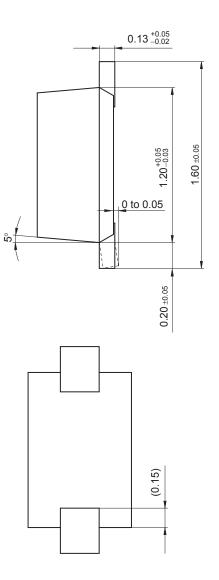


SSMini2-F5-B

Unit: mm







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